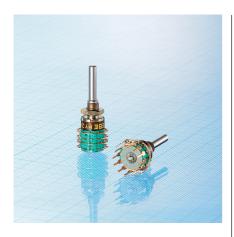


EBE

Subminiature Rotary Switch MY



Miniature rotary switch with 1 to 4 wafers.

- Multi-wafer version for conventional wiring.
- Single-wafer switch for direct PCB soldering and optional additional thread for fixing to PCB.
- 1 to 3 circuits per wafer. Detent angles 30°, 36° or 60°.
- Shorting or non-shorting mode of switching.

Special designs:

- Watertight against front panel.
 Test pressure 0,2 bar.
- Enlarged distance between wafers.
- BCD coding version with detent angle 30°.

1.0 Construction	
1.1 Number of wafers max.	4 wafers
1.2 Switching combinations per wafer Design B, detent angle 60°	
Design D, detent angle 36°	1x10 to 1x2; 2x5 to 2x2
Design E, detent angle 30°	1x12 to 1x2; 2x6 to 2x2; 3x4 to 3x2; 4x3 to 4x2 on request
1.3 Contacts	Soldering lugs, single wafer-switch also soldering pins
1.4 Mounting	Central mounting. single wafer switch soldered or optional screw mounting

2.0 Electrical Data		Ag-version	AuNi-version
2.1 Switching power max.		5VA/W	3 VA/W
2.2 Switching voltage max.		115 V-	60 V-
2.3 Switching current max.		200 mA	100 mA
2.4 Rest current max. at ∂u 20°C		1,5A	1,5 A
2.5 Test voltage at 50 Hz	between contacts	700 V	700 V
	contact/ground	800 V	800 V
2.6 Life expectancy without power		≥25000 cycles	≥ 25000 cycles
2.7 Contact resistance initial value		≤8 mΩ	$\leq 12 \mathrm{m}\Omega$
2.8 Insulation resistance		≥10 ¹¹ Ω	≥10 ¹¹ Ω
2.9 Capacity between 2 contacts		~1pF	~1 pF

3.0 Mechanical Data	
3.1 Switching mode	Shorting or non-shorting
3.2 Stops	Fixed or without stop
3.3 Operating torque acc. to design	≥3 Ncm
3.4 Stop strength	≥ 50 Ncm in the case of central mounting
	≥ 25 Ncm in the case of soldering mounting
3.5 Fastening torque max.	90 Ncm
3.6 Dust protection	Sealed wafer

4.0 Other Data			
4.1 Contact mate	erial	Ag or AuNi	
4.2 Insulating material	Wafer	Diallylphthalate, DAP; Code DI	
	Rotor	Polycarbonate, PC	
4.3 Soldering time and temperature max.		5s at 260°C	
		3s at 350°C, manual soldering	

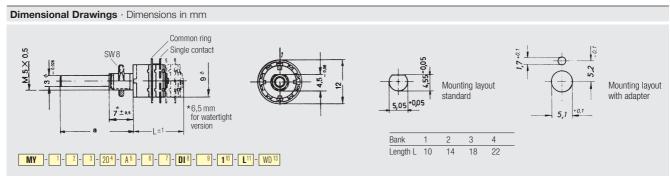


we create solutions

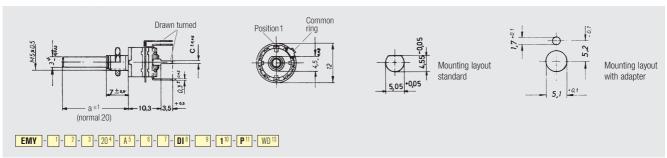
The bold-typed data in the yellow order blocks remain unchanged.

Normal-typed data match the drawings and can be modified according to your wishes.

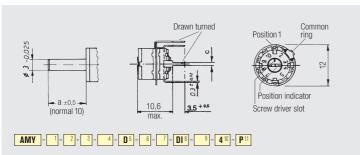
Blanks need to be completed according to the ordering details on the inside front cover.



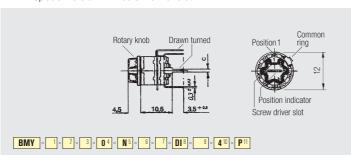
MY - With soldering lugs



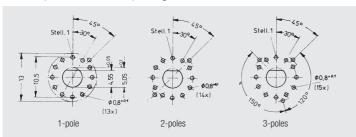
EMY - With soldering pins



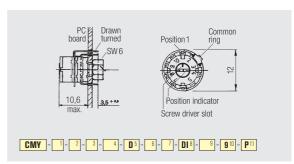
AMY - Special version with screw driver slot



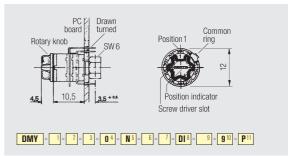
BMY - Special version with operating knob



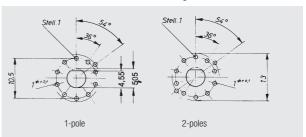
Hole location diagrams viewed from detent mechanism – detent angle 30°



CMY - With additional screw mounting



DMY - With additional screw mounting



Detent angle 36°